SJS 44 (Rev. 11/04)

CIVIL COVER SHEET

The JS 44 civil cover sheet and the information contained herein neither replace nor supplement the filing and service of pleadings or other papers as required by law, except as provided by local rules of court. This form, approved by the Judicial Conference of the United States in September 1974, is required for the use of the Clerk of Court for the purpose of initiating the civil docket sheet. (SEE INSTRUCTIONS ON THE REVERSE OF THE FORM.)

·	•				
I. (a) PLAINTIFFS		DEFENDANTS	DEFENDANTS		
Ward Cater, on behalf of I	nimself and all others similarly situated	Samsung Electron	Samsung Electronics Co., Ltd. et al. (SEE ATTACHED LIST)		
	of First Listed Plaintiff Cass XCEPT IN U.S. PLAINTIFF CASES)	NOTE: IN LAN	County of Residence of First Listed Defendant (IN U.S. PLAINTIFF CASES ONLY) NOTE: IN LAND CONDEMNATION CASES, USE THE LOCATION OF THE LAND INVOLVED.		
(c) Attorney's (Firm Name, Address, and Telephone Number)		Attorneys (If Known)	Attorneys (If Known)		
•	Montgomery, Goff & Bullis, P.C., PO Bo				
II. BASIS OF JURISD		III. CITIZENSHIP OF P	PRINCIPAL PARTIES	(Place an "X" in One Box for Plaintiff	
☐ 1 U.S. Government Plaintiff	☐ 3 Federal Question (U.S. Government Not a Party)		TF DEF I Incorporated or Priof Business In This		
U.S. Government Defendant	■ 4 Diversity (Indicate Citizenship of Parties in Item III)	Citizen of Another State	1 2 Incorporated and P of Business In A		
		Citizen or Subject of a Foreign Country	3 G 3 Foreign Nation	0606	
IV. NATURE OF SUIT					
□ 110 Insurance □ 120 Marine □ 130 Miller Act □ 140 Negotiable Instrument □ 150 Recovery of Overpayment ∞ Enforcement of Judgment □ 151 Medicare Act □ 152 Recovery of Defaulted Student Loans (Excl. Veterans) □ 153 Recovery of Overpayment of Veteran's Benefits □ 160 Stockholders' Suits □ 190 Other Contract □ 195 Contract Product Liability □ 196 Franchise □ 210 Land Condemnation □ 220 Foreclosure □ 230 Rent Lease & Ejectment □ 245 Tort Product Liability □ 290 All Other Real Property	PERSONAL INJURY 310 Airplane Product Liability	620 Other Food & Drug 625 Drug Related Seizure of Property 21 USC 881 630 Liquor Laws 640 R.R. & Truck 650 Airline Regs. 660 Occupational Safety/Health 690 Other 710 Fair Labor Standards Act 720 Labor/Mgmt. Relations 730 Labor/Mgmt. Reporting & Disclosure Act 740 Railway Labor Act 740 Railway Labor Act 790 Other Labor Litigation 791 Empl. Ret. Inc. Security Act	422 Appeal 28 USC 158 423 Withdrawal 28 USC 157 PROPERTY RIGHTS 820 Copyrights 830 Patent 840 Trademark 861 HIA (1395ff) 862 Black Lung (923) 863 DIWC/DIWW (405(g)) 864 SSID Title XVI 865 RSI (405(g)) FEDERAL TAX SUITS 870 Taxes (U.S. Plaintiff or Defendant) 871 IRS—Third Party 26 USC 7609	OTHER STATUTES ☐ 400 State Reapportionment 410 Antitrust ☐ 430 Banks and Banking ☐ 450 Commerce ☐ 460 Deportation ☐ 470 Racketeer Influenced and Corrupt Organizations ☐ 480 Consumer Credit ☐ 490 Cable/Sat TV ☐ 810 Selective Service ☐ 850 Securities/Commodities/ Exchange ☐ 875 Customer Challenge ☐ 12 USC 3410 ☐ 890 Other Statutory Actions ☐ 891 Agricultural Acts ☐ 892 Economic Stabilization Act ☐ 893 Environmental Matters ☐ 894 Energy Allocation Act ☐ 895 Freedom of Information Act ☐ 900Appeal of Fee Determination Under Equal Access to Justice ☐ 950 Constitutionality of State Statutes	
■1 Original □2 R	emoved from Appellate Court Cite the U.S. Civil Statute under which you a	Reinstated or anoth Reopened (speci			
VI. CAUSE OF ACTIO	· ·	To ming (50 not the jurisurenon	ar statutes unless diversity).		
VII. REQUESTED IN COMPLAINT:	CHECK IF THIS IS A CLASS ACTION UNDER F.R.C.P. 23	N DEMAND \$	CHECK YES only JURY DEMAND:	if demanded in complaint: Yes No	
VIII. RELATED CASI IF ANY	E(S) (See instructions): JUDGE		DOCKET NUMBER		
DATE	SIGNATURE OF AT	TORNEY OF RECORD	a)		
	MOUNT APPLYING IFP	JUDGE	MAG. JUE	OGE	

Civil Cover Sheet Attached List

Samsung Electronics Co., Ltd.; Samsung Semiconductor, Inc.; Hynix Semiconductor, Inc.; Hynix Semiconductor America, Inc.; Micron Technology, Inc.; Micron Semiconductor Products, Inc.; NEC Electronics America, Inc.; Cypress Semiconductor, Inc.; Alliance Semiconductor Corporation; Fujitsu Ltd.; Fujitsu America, Inc.; Hitachi Ltd.; Hitachi America Ltd.; Mitsubishi Electric Corporation; Mitsubishi Electric & Electronics USA, Inc.; Renesas Technology Corporation; Renesas Technology America, Inc.; Sony Corporation; Sony Corporation of America; Sony Electronics, Inc.; Toshiba Corporation; Toshiba America Corporation; Toshiba America Electronic Components, Inc.